

$V_{RRM}$	=	4500 V
$I_{FAVM}$	=	900 A
$I_{FSM}$	=	16 kA
$V_{F0}$	=	1.8 V
$r_F$	=	0.9 m $\Omega$
$V_{DClink}$	=	2400 V

## Fast Recovery Diode

# 5SDF 07H4501

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- Patented free-floating silicon technology
- Low switching losses
- Optimized for use as large-area snubber diode in GTO converters
- Industry standard press-pack ceramic housing, hermetically plasma-welded
- Cosmic radiation withstand rating

### Blocking

$V_{RRM}$	Repetitive peak reverse voltage	4500 V	Half sine wave, $t_p = 10$ ms, $f = 50$ Hz	
$I_{RRM}$	Repetitive peak reverse current	$\leq 200$ mA	$V_R = V_{RRM}$ , $T_J = 125^\circ\text{C}$	
$V_{DClink}$	Permanent DC voltage for 100 FIT failure rate	2400 V	100% Duty	Ambient cosmic radiation at sea level in open air.
$V_{DClink}$	Permanent DC voltage for 100 FIT failure rate	2800 V	5% Duty	

### Mechanical data (see Fig. 8)

$F_m$	Mounting force	min.	36 kN	
		max.	44 kN	
a	Acceleration: Device unclamped Device clamped		50 m/s <sup>2</sup>	
			200 m/s <sup>2</sup>	
m	Weight		0.83 kg	
$D_s$	Surface creepage distance	$\geq$	30 mm	
$D_a$	Air strike distance	$\geq$	20 mm	

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**On-state** (see Fig. 2, 3)

$I_{FAVM}$	Max. average on-state current	900 A	Half sine wave, $T_c = 85^\circ\text{C}$	
$I_{FRMS}$	Max. RMS on-state current	1400 A		
$I_{FSM}$	Max. peak non-repetitive surge current	16 kA	$t_p = 10 \text{ ms}$	Before surge: $T_c = T_j = 125^\circ\text{C}$
		40 kA	$t_p = 1 \text{ ms}$	
$\int I^2 dt$	Max. surge current integral	$1.28 \cdot 10^6 \text{ A}^2\text{s}$	$t_p = 10 \text{ ms}$	After surge: $V_R \approx 0 \text{ V}$
		$0.8 \cdot 10^6 \text{ A}^2\text{s}$	$t_p = 1 \text{ ms}$	
$V_F$	Forward voltage drop	$\leq 4.5 \text{ V}$	$I_F = 3000 \text{ A}$	$T_j = 125^\circ\text{C}$
$V_{F0}$	Threshold voltage	1.8 V	Approximation for	
$r_F$	Slope resistance	0.9 m $\Omega$	$I_F = 500 \dots 5000 \text{ A}$	

**Turn-on** (see Fig. 4, 5)

$V_{fr}$	Peak forward recovery voltage	$\leq 55 \text{ V}$	$di/dt = 500 \text{ A}/\mu\text{s}$ , $T_j = 125^\circ\text{C}$
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**Turn-off** (see Fig. 6, 7)

$I_{rr}$	Reverse recovery current	$\leq 260 \text{ A}$	$di/dt = 100 \text{ A}/\mu\text{s}$ , $I_F = 1000 \text{ A}$ , $T_j = 125^\circ\text{C}$ , $R_S = 22\Omega$ , $C_S = 0.22\mu\text{F}$
$Q_{rr}$	Reverse recovery charge	$\leq 1700 \mu\text{C}$	

**Thermal** (see Fig. 1)

$T_j$	Operating junction temperature range	-40...125 $^\circ\text{C}$		
$T_{stg}$	Storage temperature range	-40...125 $^\circ\text{C}$		
$R_{thJC}$	Thermal resistance junction to case	$\leq 24 \text{ K/W}$	Anode side cooled	$F_m = 36 \dots 44 \text{ kN}$
		$\leq 24 \text{ K/W}$	Cathode side cooled	
		$\leq 12 \text{ K/W}$	Double side cooled	
$R_{thCH}$	Thermal resistance case to heatsink	$\leq 6 \text{ K/W}$	Single side cooled	
		$\leq 3 \text{ K/W}$	Double side cooled	

Analytical function for transient thermal impedance.

$$Z_{thJC}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(\text{K/W})$	7.44	2.00	1.84	0.71
$\tau_i(\text{s})$	0.47	0.091	0.011	0.0047
$F_m = 36 \dots 44 \text{ kN}$ Double side cooled				

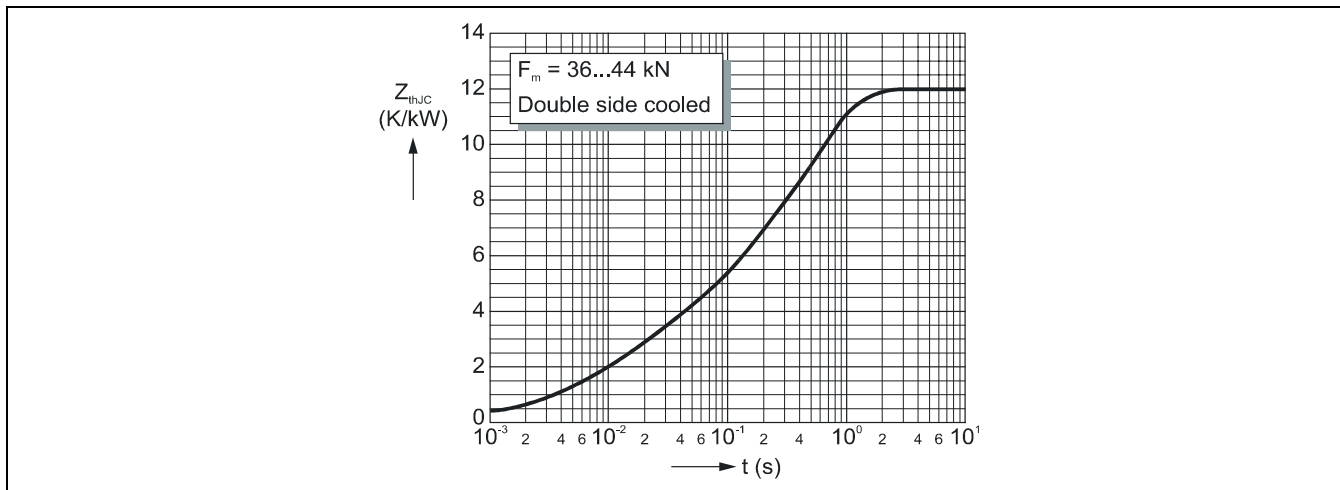


Fig. 1 Transient thermal impedance (junction-to-case) vs. time in analytical and graphical form (max. values).

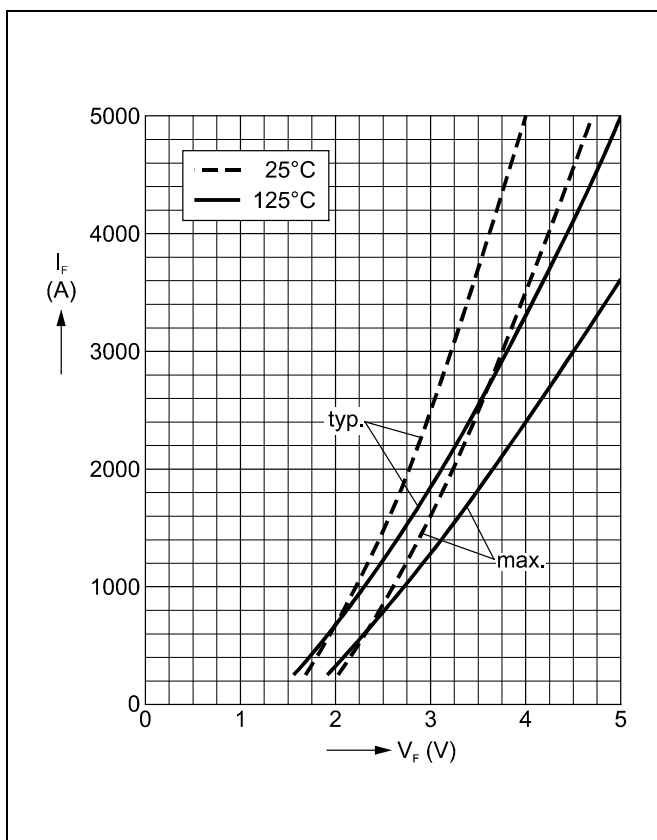


Fig. 2 Forward current vs. forward voltage (typ. and max. values) and linear approximation of max. curve at 125°C.

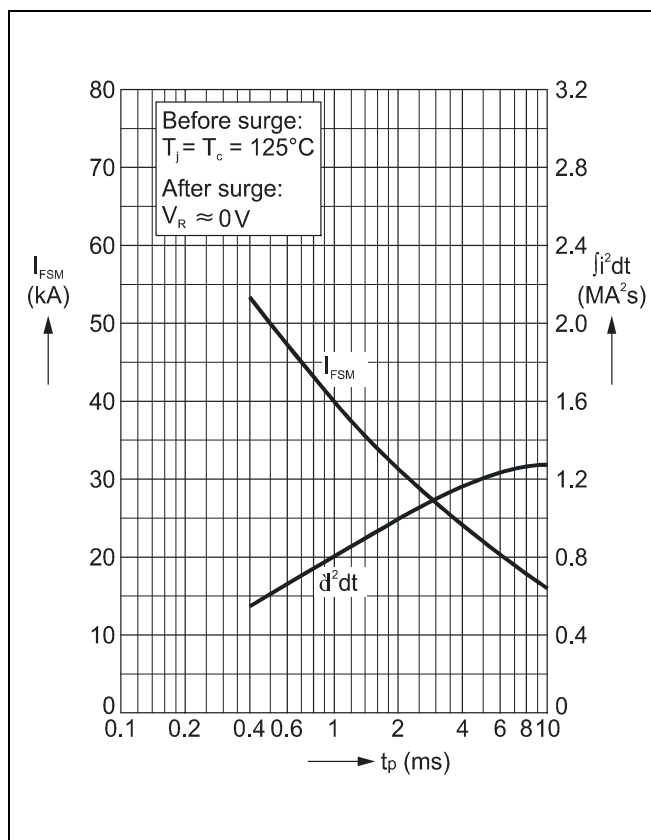


Fig. 3 Surge current and fusing integral vs. pulse width (max. values) for non-repetitive, half-sinusoidal surge current pulses.

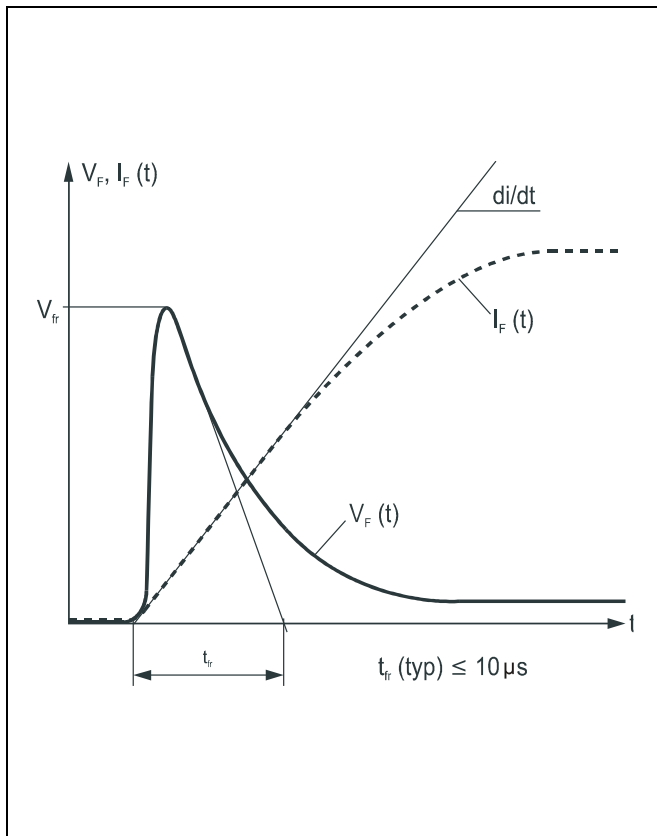


Fig. 4 Typical forward voltage waveform when the diode is turned on with a high di/dt.

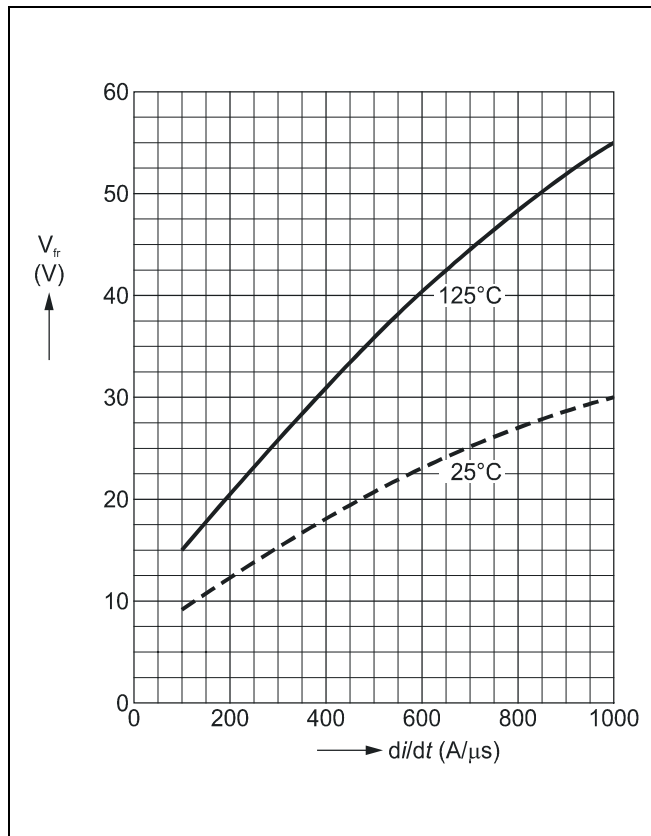


Fig. 5 Forward recovery voltage vs. turn-on di/dt (max. values).

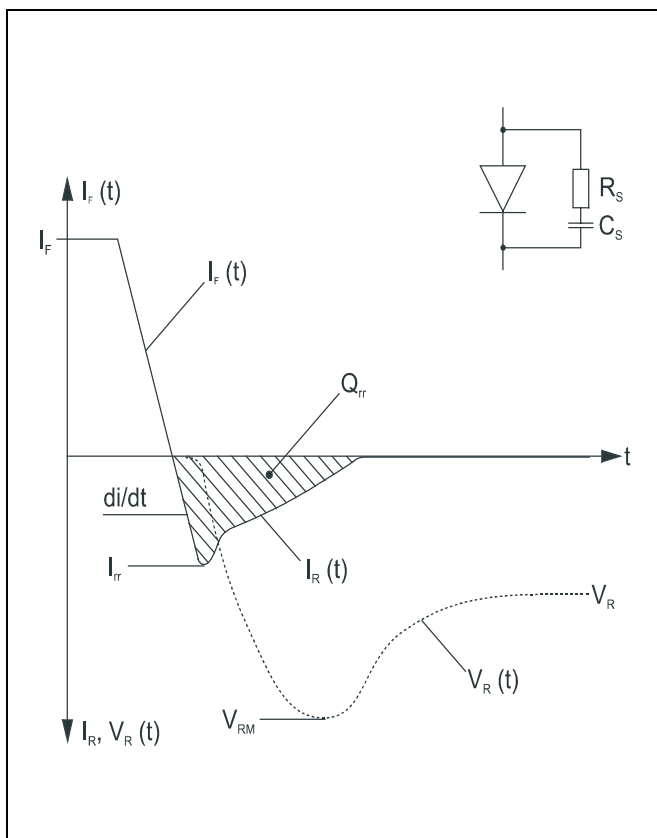


Fig. 6 Typical current and voltage waveforms at turn-off when the diode is connected to an RCD snubber, as often used in GTO circuits.

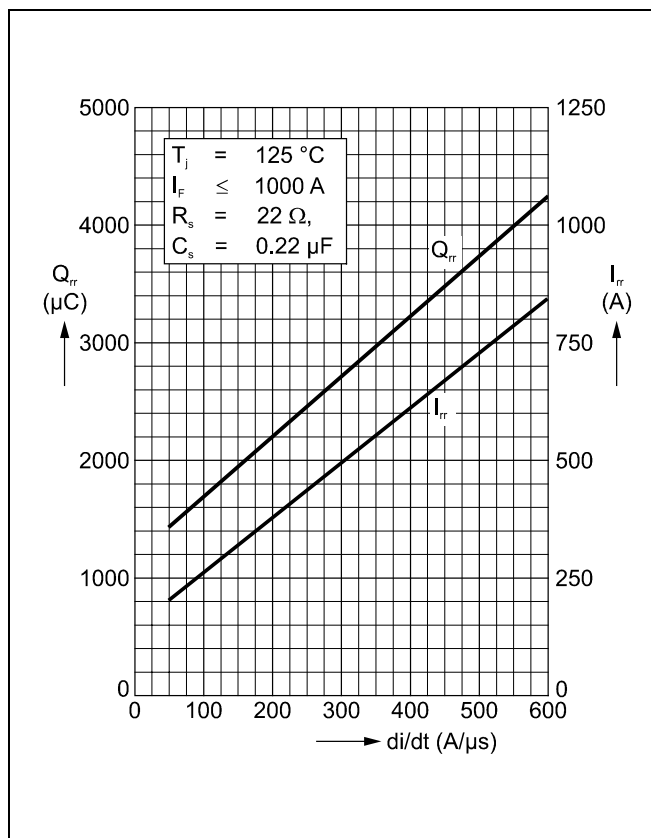


Fig. 7 Reverse recovery current vs. turn off di/dt (max. values).

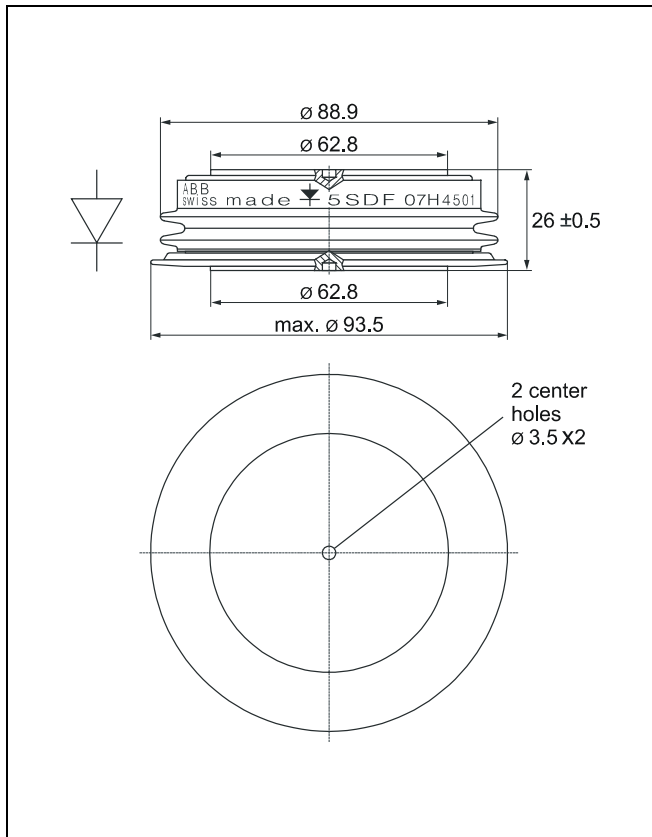


Fig. 8 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

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